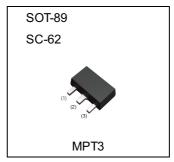
High gain amplifier transistor (25V / 2A)

Parameter	Value
V _{CEO}	25V
IC	2A

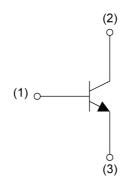
Outline



Features

1)Low saturation voltage.
 typically V_{CE(sat)}=120mV at I_C/I_B=1A/20mA
 2)High DC current gain

●Inner circuit



- (1) Base
- (2) Collector
- (3) Emitter

Application

LOW FREQUENCY POWER AMP

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
2SD2153	SOT-89 (MPT3)	4540	T100	180	12	1000	DN

● Absolute maximum ratings (T_a = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	V_{CBO}	30	V
Collector-emitter voltage	V _{CEO}	25	V
Emitter-base voltage	V _{EBO}	6	V
Calle atom assume mt	I _C	2	Α
Collector current	I _{CP} *1	3	Α
Dower discinction	P _D *2	0.5	W
Power dissipation	P _D *3	2.0	W
Junction temperature	T _j	150	°C
Range of storage temperature	T _{stg}	-55 to +150	°C

● Electrical characteristics (T_a = 25°C)

Davanastav	Currele el	Canditions	Values			1.1-24
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV _{CBO}	I _C = 50μA	30	-	-	V
Collector-emitter breakdown voltage	BV _{CEO}	I _C = 1mA	25	-	-	V
Emitter-base breakdown voltage	BV _{EBO}	I _E = 50μA	6	-	-	V
Collector cut-off current	I _{CBO}	V _{CB} = 20V	-	-	500	nA
Emitter cut-off current	I _{EBO}	V _{EB} = 5V	-	-	500	nA
Collector-emitter saturation voltage	V _{CE(sat)} *4	I _C = 1A, I _B = 20mA	-	-	500	mV
DC current gain	h _{FE} *4	$V_{CE} = 6V, I_{C} = 0.5A$	560	-	2700	-
Transition frequency	f _T	$V_{CE} = 10V, I_{E} = -10mA,$ f = 100MHz	-	110	-	MHz
Output capacitance	C _{ob}	$V_{CB} = 10V$, $I_E = 0A$, $f = 1MHz$	-	22	-	pF

hFE values are calssified as follows:

rank	U	V	W	-	-
h _{FE}	560-1200	820-1800	1200-2700	-	-

^{*1} Single Pulse, Pw=10ms



^{*2} Each terminal mounted on a reference land.

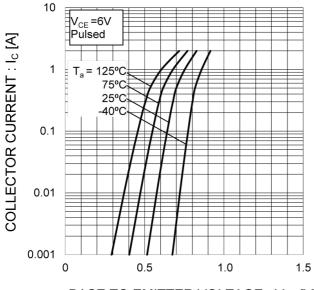
^{*3} Mounted on a 40×40×0.7mm ceramic board.

^{*4} Pulsed

● Electrical characteristic curves(T_a = 25°C)

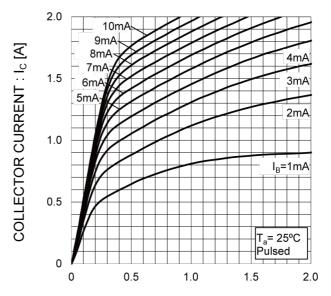
Fig.1 Ground Emitter Propagation

Characteristics



BASE TO EMITTER VOLTAGE : VBE [V]

Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V_{CE} [V]

Fig.3 DC Current Gain vs. Collector Current (I)

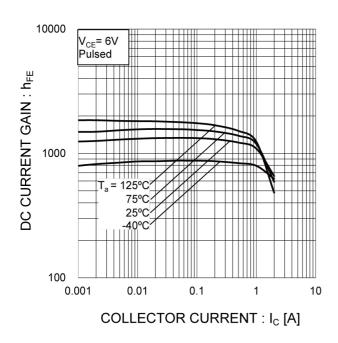
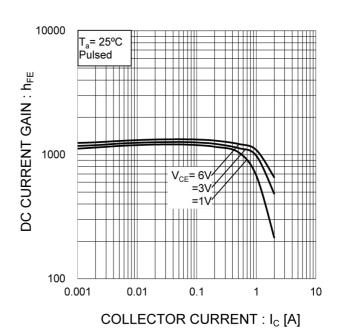


Fig.4 DC Current Gain vs. Collector Current (II)



● Electrical characteristic curves(T_a = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current (I)

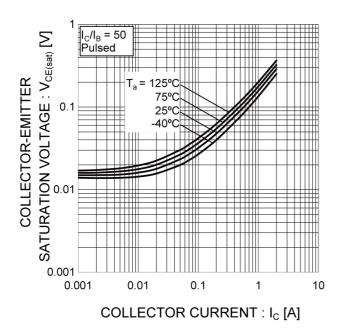


Fig.6 Collector-Emitter Saturation

Voltage vs. Collector Current (II)

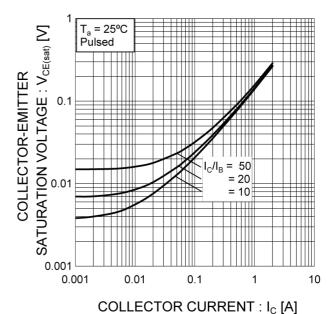


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

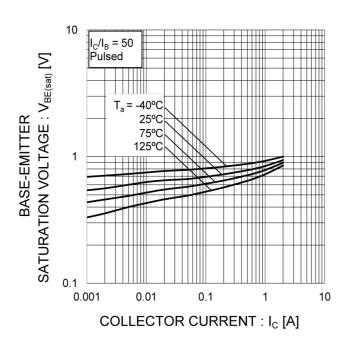
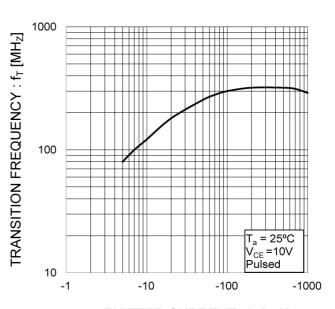


Fig.8 Gain Bandwidth Product vs.

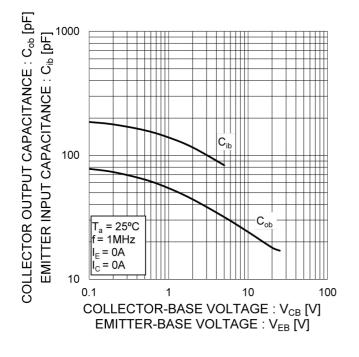
Emitter Current

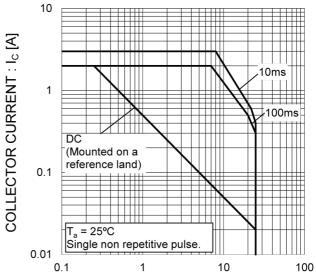


● Electrical characteristic curves(T_a = 25°C)

Fig.9 Emitter Input Capacitance vs.
Emitter-Base Voltage
Collector Output Capacitance vs.
Collector-Base Voltage

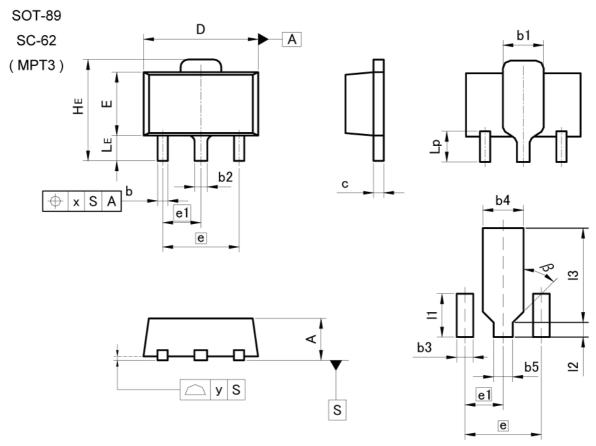
Fig.10 Safe Operating Area





COLLECTOR TO EMITTER VOLTAGE : $V_{CE}\left[V\right]$

Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

	MILIM	ETERS	INC	HES	
DIM	7/10/20/20/20				
	MIN	MAX	MIN	MAX	
A	1.40	1.60	0.055	0.063	
b	0.30	0.50	0.012	0.020	
b1	1.50	1.70	0.059	0.067	
b2	0.40	0.60	0.016	0.024	
С	0.35	0.50	0.014	0.020	
D	4.40	4.70	0.173	0.185	
E	2.40	2.70	0.094	0.106	
е	3.	00	0.1	18	
e1	1.	50	0.059		
HE	3.70	4.30	0.146	0.169	
LE	0.80	1.20	0.031	0.047	
Lp	1.01	1.41	0.040	0.056	
X		0.15	- :	0.006	
У	-	0.10	-	0.004	

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b3	-	0.65	-	0.026
b4	_	1.70	1	0.067
b5	- ->	0.75	= 1	0.030
l1	-1	1.71	-	0.067
12	-/	0.58	ī	0.023
13	20	3.72	_	0.146
β	45°		45	0

Dimension in mm/inches



Notice

Precaution on using ROHM Products

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(Note1) Medical Equipment Classification of the Specific Applications

1 /	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1		
JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSIII	CLASS II b	CL ACCTI
CLASSIV	CLASSIII	CLASSⅢ	CLASSⅢ

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

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Notice-PGA-E Rev.003



2SD2153 - Web Page

Distribution Inventory

Part Number	2SD2153
Package	MPT3
Unit Quantity	1000
Minimum Package Quantity	1000
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes

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